

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6026969

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ZONG ZONG	02/07/2020
JIEZHU JIN	02/10/2020
NAFIH MEKHILEF	02/17/2020
RECEIVING PARTY DATA	
Name:	SAINT-GOBAIN PERFORMANCE PLASTICS CORPORATION
Street Address:	31500 SOLON ROAD
City:	SOLON
State/Country:	OHIO
Postal Code:	44139
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16731248
CORRESPONDENCE DATA	
Fax Number:	(512)795-7677
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	mail@abel-ip.com
Correspondent Name:	ABEL SCHILLINGER, LLP
Address Line 1:	5929 BALCONES DRIVE
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ATTORNEY DOCKET NUMBER:	18-OE-0373US02
NAME OF SUBMITTER:	ELIZABETH COFFEE
SIGNATURE:	/Elizabeth Coffee/
DATE SIGNED:	03/23/2020
Total Attachments: 4	
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ASSIGNMENT OF INVENTION

For good and valuable consideration, the receipt of which is hereby acknowledged,
I, an ASSIGNOR named below,

Zong ZONG of Southborough, MA 01772 United States of America

Jiezhu JIN of Westborough, MA 01581 United States of America

Nafih MEKHILEF of Shrewsbury, MA 01545 United States of America

hereby sell, assign and transfer to

ASSIGNEE: SAINT-GOBAIN PERFORMANCE PLASTICS CORPORATION, a
California Corporation, having a principal place of business at 31500
Solon Road, Solon, Ohio, 44139, United States of America,

its successors, assigns and legal representatives, my entire right, title and interest throughout the
world, including all rights to claim priority, in and to the invention(s) disclosed in:

- U.S. Patent Application executed on or about the date of this Assignment,
- U.S. Patent Application executed on _____, or
- U.S. Provisional Application No.: 16731248, filed on December 31, 2019,
- U.S. Application No.: _____, filed on _____
- International Application No.: PCT/_____, filed on _____

ENTITLED: **SEAL INCLUDING COATING AND METHOD OF FORMING,**
and naming as

INVENTOR(S): Zong ZONG, Jiezhu JIN, Nafih MEKHILEF.

("Invention") including without limitation, my entire right, title and interest in and to any and all
United States and foreign applications (including international, regional and foreign national
applications) for said Invention, including divisions, continuations, continuations-in-part, utility
models, industrial designs, renewals, substitutes and extensions thereof, and in and to any and all
patents, invention registrations, or other forms of protection ("Patents") of every country or
region that may be granted or have been granted for said Invention, including any reissues and
reexaminations thereof.

To comply with 37 C.F.R. § 3.21 for recording this Assignment, I authorize and request that the
application number and filing date be inserted here, if not already shown above,
(____/____, filed _____) when they become known.

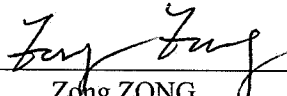

I authorize Assignee to apply for and be granted patents in the United States and foreign
countries for said Invention, and to claim all rights of priority without further authorization from
me.

ASSIGNMENT OF INVENTION

I agree that, upon request and without further compensation, but at no expense to me, I and/or my legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing the Patents in the United States and throughout the world for said Invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said Invention, said application, and any Patents granted for said Invention in the United States and throughout the world.

I hereby covenant that no assignment, sale, license, agreement, or encumbrance has been or will be made or entered into that would conflict with this Assignment.

I authorize and request the Director of the United States Patent and Trademark Office and agencies, departments, or other similar offices and officials of all foreign countries to issue any Patents granted for said Invention, whether on said application or on any subsequently filed divisional, continuation, continuation-in-part, reexamination, reissue or other application, to Assignee, its successors and assigns, as the assignee of the entire interest in said Invention.

Executed on	<u>02-07</u>	, 202 <u>0</u>	by	
	[Month-day-year]			Zong ZONG
Witnessed on	<u>02-07</u>	, 202 <u>0</u>	by	
	[Month-day-year]			Non-inventor Witness Signature

Executed on	_____	, 202__	by	_____
	[Month-day-year]			Jiezhong JIN
Witnessed on	_____	, 202__	by	_____
	[Month-day-year]			Non-inventor Witness Signature

Executed on	_____	, 202__	by	_____
	[Month-day-year]			Nafih MEKHILEF
Witnessed on	_____	, 202__	by	_____
	[Month-day-year]			Non-inventor Witness Signature

ASSIGNMENT OF INVENTION

I agree that, upon request and without further compensation, but at no expense to me, I and/or my legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing the Patents in the United States and throughout the world for said Invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said Invention, said application, and any Patents granted for said Invention in the United States and throughout the world.

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Executed on _____, 202__ by _____, [Month-day-year] Zong ZONG
Witnessed on _____, 202__ by _____, [Month-day-year] Non-inventor Witness Signature

Executed on <u>2-10</u> , 202 <u>0</u> by <u>Jiezhn Jin</u> , [Month-day-year] Jiezhn JIN
Witnessed on <u>2/10/</u> , 202 <u>0</u> by <u>[Signature]</u> , [Month-day-year] Non-inventor Witness Signature

Executed on _____, 202__ by _____, [Month-day-year] Nafih MEKHILEF
Witnessed on _____, 202__ by _____, [Month-day-year] Non-inventor Witness Signature

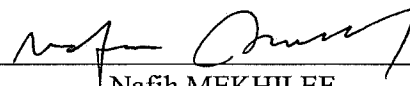
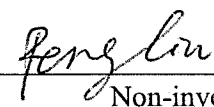
I agree that, upon request and without further compensation, but at no expense to me, I and/or my legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing the Patents in the United States and throughout the world for said Invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said Invention, said application, and any Patents granted for said Invention in the United States and throughout the world.

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I authorize and request the Director of the United States Patent and Trademark Office and agencies, departments, or other similar offices and officials of all foreign countries to issue any Patents granted for said Invention, whether on said application or on any subsequently filed divisional, continuation, continuation-in-part, reexamination, reissue or other application, to Assignee, its successors and assigns, as the assignee of the entire interest in said Invention.

Executed on _____, 202__ by _____, [Month-day-year] Zong ZONG
Witnessed on _____, 202__ by _____, [Month-day-year] Non-inventor Witness Signature

Executed on _____, 202__ by _____, [Month-day-year] Jiezhui JIN
Witnessed on _____, 202__ by _____, [Month-day-year] Non-inventor Witness Signature

Executed on <u>02/17/2020</u> , 202 <u>0</u> by <u></u> , [Month-day-year] Nafih MEKHILEF
Witnessed on <u>02/17/2020</u> , 202__ by <u></u> , [Month-day-year] Non-inventor Witness Signature